The Original Sil-Pad Material

#### **Features and Benefits**

- Thermal impedance: 1.13°C-in²/W (@50 psi)
- · Original Sil-Pad material
- Excellent mechanical and physical characteristics
- Flame retardant



Sil-Pad 400 is a composite of silicone rubber and fiberglass. The material is flame retardant and is specially formulated for use as a thermally conductive insulator. The primary use for Sil-Pad 400 is to electrically isolate power sources from heat sinks.

Sil-Pad 400 has excellent mechanical and physical characteristics. Surfaces are pliable and allow complete surface contact with excellent heat dissipation. Sil-Pad 400 actually improves its thermal resistance with age. The reinforcing fiberglass provides excellent cut-through resistance. In addition, Sil-Pad 400 is non-toxic and resists damage from cleaning agents.

TYPICAL PROPERTIES OF SIL-PAD 400						
PROPERTY	IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Color	Gray		Gray		Visual	
Reinforcement Carrier	Fiberglass		Fiberglass		_	
Thickness (inch) / (mm)	0.007, 0.009		0.178, 0.229		ASTM D374	
Hardness (Shore A)	85		85		ASTM D2240	
Breaking Strength (lbs/inch) / (kN/m)	30		5		ASTM D1458	
Elongation (%45° to Warp and Fill)	54		54		ASTM D412	
Tensile Strength (psi) / (MPa)	3000		20		ASTM D412	
Continuous Use Temp (°F) / (°C)	-76 to 356		-60 to 180		_	
ELECTRICAL						
Dielectric Breakdown Voltage (Vac)	3500, 4500		3500, 4500		ASTM D149	
Dielectric Constant (1000 Hz)	5.5		5.5		ASTM D150	
Volume Resistivity (Ohm-meter)	1011		10"		ASTM D257	
Flame Rating	V-O		V-O		U.L. 94	
THERMAL						
Thermal Conductivity (W/m-K)	0.9		0.9		ASTM D5470	
THERMAL PERFORMANCE vs PRESSURE						
Press	sure (psi)	10	25	50	100	200
TO-220 Thermal Performance (°C/W) 0.007"		6.62	5.93	5.14	4.38	3.61
TO-220 Thermal Performance (°C/W) 0.009"		8.51	7.62	6.61	5.63	4.64
Thermal Impedance (°C-in²/W) 0.007" (1)		1.82	1.42	1.13	0.82	0.54
Thermal Impedance (°C-in²/W) 0.009" (1)		2.34	1.83	1.45	1.05	0.69
I) The ASTM D5470 (Bergquist modified) test fixture	e was used.The	recorded va	lue includes in	terfacial therr	nal resistance."	These

### **Typical Applications Include:**

• Power supplies

pressure applied

• Automotive electronics

values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and

Motor controls

- Power semiconductors
- U.L. File Number E59150
- FSCM Number 55285

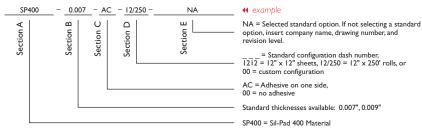
- Military Specifications:
  - MIL-M-38527/8A
- MIL-M-38527C
- MIL-I-49456
- MIL-M-87111

## **Configurations Available:**

• Sheet form, die-cut parts, and roll form; with or without pressure sensitive adhesive

# **Building a Part Number**

# **Standard Options**



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad® U.S. Patents 4.574.879; 4.602.125; 4.602.678; 4.685.987; 4.842.911 and others



www.bergquistcompany.com